

IS62LV2568L IS62LV2568LL

256K x 8 LOW POWER and LOW Vcc CMOS STATIC RAM

FEATURES

- Access times of 55, 70, 100 ns
- Low active power: 126 mW (max, L, LL)
- Low standby power: 36 μ W (max, L) and 7.2 μ W (max, LL) CMOS standby
- Low data retention voltage: 1.5V (min.)
- Available in Low Power (-L) and Ultra-Low Power (-LL)
- Output Enable (\overline{OE}) and two Chip Enable
- TTL compatible inputs and outputs
- Single 2.7V-3.6V power supply
- Available in the 32-pin 8x20mm TSOP-1, 32-pin 8x13.4mm TSOP-1 and 48-pin 6*8mm TF-BGA

DESCRIPTION

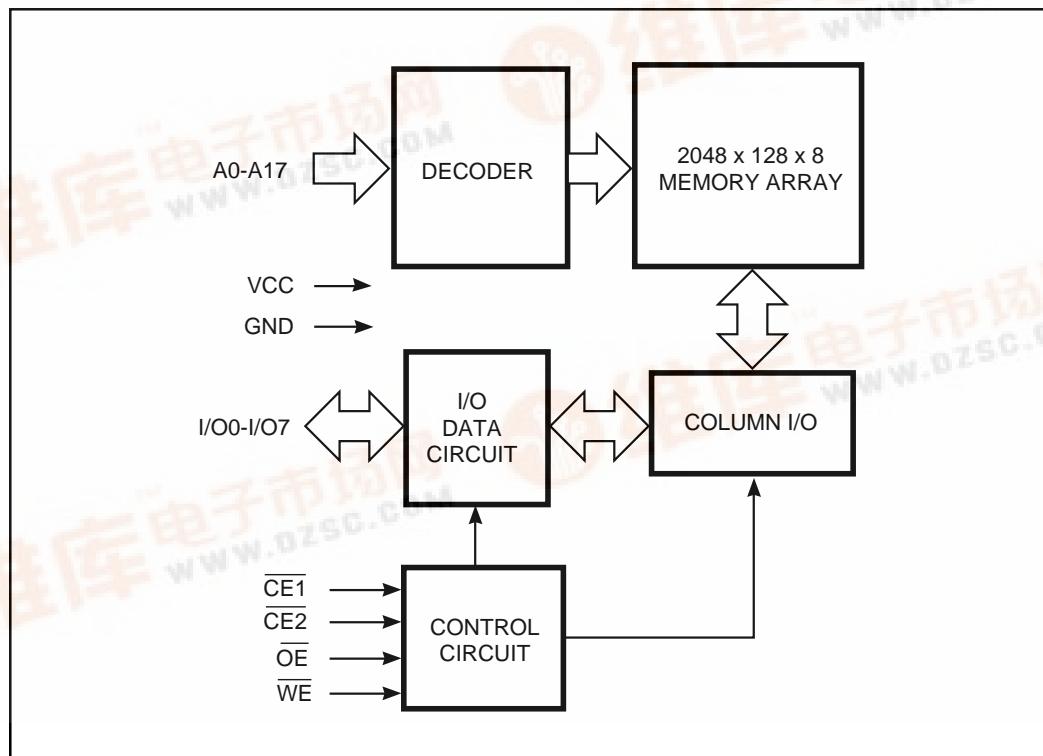
The *ICSI* IS62LV2568L and IS62LV2568LL are low power and low Vcc, 262,144-bit words by 8 bits CMOS static RAMs. They are fabricated using *ICSI*'s high-performance CMOS technology. This highly reliable process coupled with innovative circuit design techniques, yields higher performance and low power consumption devices.

When $\overline{CE1}$ is HIGH or $CE2$ is LOW (deselected), the device assumes a standby mode at which the power dissipation can be reduced by using CMOS input levels.

Easy memory expansion is provided by using two Chip Enable inputs, $\overline{CE1}$ and $CE2$. The active LOW Write Enable (\overline{WE}) controls both writing and reading of the memory.

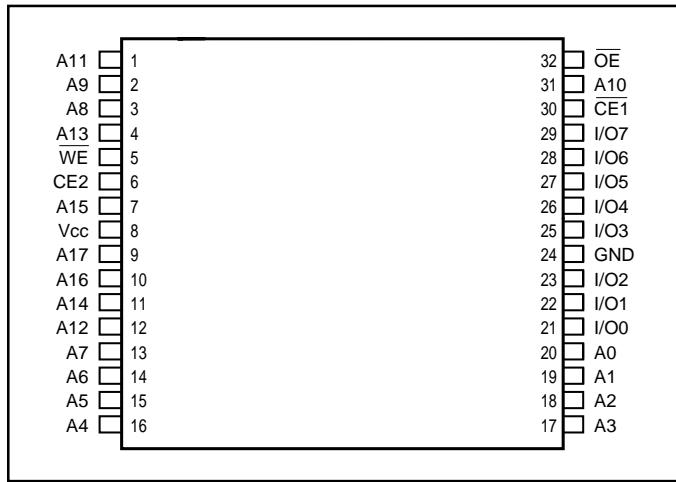
The IS62LV2568L and IS62LV2568LL are available in 32-pin 8*20mm TSOP-1, 8*13.4mm TSOP-1 and 48-pin 6*8mm TF-BGA.

FUNCTIONAL BLOCK DIAGRAM

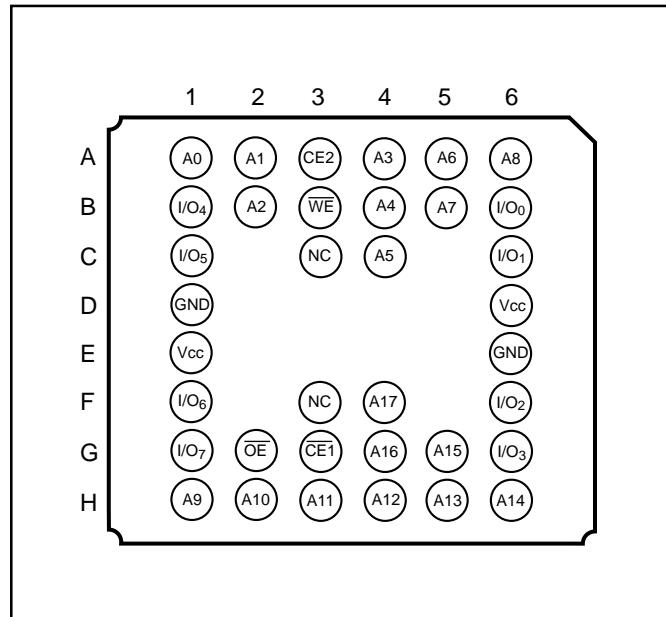


PIN CONFIGURATIONS

32-Pin 8*20mm TSOP-1, 8*13.4mm STSOP-1



48-Pin 6*8mm TF-BGA



PIN DESCRIPTIONS

A0-A17	Address Inputs
CE1	Chip Enable 1 Input
CE2	Chip Enable 2 Input
OE	Output Enable Input
WE	Write Enable Input
I/O0-I/O7	Data Input/Output
NC	No Connection
Vcc	Power
GND	Ground

OPERATING RANGE

Range	Ambient Temperature	Vcc
Commercial	0°C to +70°C	2.7V - 3.6V
Industrial	-40°C to +85°C	2.7V - 3.6V

TRUTH TABLE

Mode	WE	CE1	CE2	OE	I/O Operation	Vcc Current
Not Selected (Power-down)	X	H	X	X	High-Z	IsB1, IsB2
	X	X	L	X	High-Z	IsB1, IsB2
Output Disabled	H	L	H	H	High-Z	Icc
Read	H	L	H	L	DOUT	Icc
Write	L	L	H	X	DIN	Icc

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Parameter	Value	Unit
VTERM	Terminal Voltage with Respect to GND	-0.5 to Vcc + 0.5	V
Vcc	Vcc related to GND	-0.3 to +4.0	V
TBIAS	Temperature Under Bias	-40 to +85	°C
TSTG	Storage Temperature	-65 to +150	°C
PT	Power Dissipation	0.7	W

Notes:

1. Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

CAPACITANCE⁽¹⁾

Symbol	Parameter	Conditions	Max.	Unit
CIN	Input Capacitance	V _{IN} = 0V	6	pF
COUT	Output Capacitance	V _{OUT} = 0V	8	pF

Notes:

1. Tested initially and after any design or process changes that may affect these parameters.

DC ELECTRICAL CHARACTERISTICS (Over Operating Range)

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	V _{CC} = Min., I _{OH} = -1.0 mA	2.2	—	V
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 2.1 mA	—	0.4	V
V _{IH}	Input HIGH Voltage		2.2	V _{CC} + 0.3	V
V _{IL⁽¹⁾}	Input LOW Voltage ⁽¹⁾		-0.3	0.4	V
I _{LI}	Input Leakage	GND ≤ V _{IN} ≤ V _{CC}	-1	1	µA
I _{LO}	Output Leakage	GND ≤ V _{OUT} ≤ V _{CC}	-1	1	µA

Notes:

1. V_{IL} = -2.0V for pulse width less than 10 ns.

IS62LV2568L POWER SUPPLY CHARACTERISTICS⁽¹⁾ (Over Operating Range)

Symbol	Parameter	Test Conditions	-55		-70		-100		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	
I _{CC}	V _{CC} Dynamic Operating Supply Current	V _{CC} = Max., I _{OUT} = 0 mA, f = f _{MAX}	Com.	—	40	—	30	—	20 mA
			Ind.	—	45	—	35	—	25
I _{SB1}	TTL Standby Current (TTL Inputs)	V _{CC} = Max., V _{IN} = V _{IH} or V _{IL} , CE1 ≥ V _{IH} or CE2 ≤ V _{IL} , f = 0	Com.	—	0.4	—	0.4	—	0.4 mA
			Ind.	—	1.0	—	1.0	—	1.0
I _{SB2}	CMOS Standby Current (CMOS Inputs)	V _{CC} = Max., f = 0 CE1 ≥ V _{CC} – 0.2V, CE2 ≤ 0.2V, or V _{IN} ≥ V _{CC} – 0.2V, V _{IN} ≤ 0.2V	Com.	—	35	—	35	—	35 µA
			Ind.	—	50	—	50	—	50

Note:

1. At f = f_{MAX}, address and data inputs are cycling at the maximum frequency, f = 0 means no input lines change.

IS62LV2568LL POWER SUPPLY CHARACTERISTICS⁽¹⁾ (Over Operating Range)

Symbol	Parameter	Test Conditions	-55		-70		-100		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	
I _{CC}	V _{CC} Dynamic Operating Supply Current	V _{CC} = Max., I _{OUT} = 0 mA, f = f _{MAX}	Com.	—	40	—	30	—	20 mA
			Ind.	—	45	—	35	—	25
I _{SB1}	TTL Standby Current (TTL Inputs)	V _{CC} = Max., V _{IN} = V _{IH} or V _{IL} , CE1 ≥ V _{IH} or CE2 ≤ V _{IL} , f = 0	Com.	—	0.4	—	0.4	—	0.4 mA
			Ind.	—	1.0	—	1.0	—	1.0
I _{SB2}	CMOS Standby Current (CMOS Inputs)	V _{CC} = Max., f = 0 CE ≥ V _{CC} – 0.2V, CE2 ≤ 0.2V, or V _{IN} ≥ V _{CC} – 0.2V, V _{IN} ≤ 0.2V	Com.	—	10	—	10	—	10 µA
			Ind.	—	15	—	15	—	15

Note:

1. At f = f_{MAX}, address and data inputs are cycling at the maximum frequency, f = 0 means no input lines change.

READ CYCLE SWITCHING CHARACTERISTICS⁽¹⁾ (Over Operating Range)

Symbol	Parameter	-55		-70		-100		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	
t_{RC}	Read Cycle Time	55	—	70	—	100	—	ns
t_{AA}	Address Access Time	—	55	—	70	—	100	ns
t_{OHA}	Output Hold Time	10	—	10	—	15	—	ns
t_{ACE1}	$\overline{CE1}$ Access Time	—	55	—	70	—	100	ns
t_{ACE2}	CE2 Access Time	—	55	—	70	—	100	ns
t_{DOE}	\overline{OE} Access Time	—	30	—	35	—	50	ns
$t_{LZOE}^{(2)}$	\overline{OE} to Low-Z Output	5	—	5	—	5	—	ns
$t_{HZOE}^{(2)}$	\overline{OE} to High-Z Output	—	20	0	25	0	30	ns
$t_{LZCE1}^{(2)}$	$\overline{CE1}$ to Low-Z Output	10	—	10	—	10	—	ns
$t_{LZCE2}^{(2)}$	CE2 to Low-Z Output	10	—	10	—	10	—	ns
$t_{HZCE}^{(2)}$	$\overline{CE1}$ or CE2 to Low-Z Output	0	20	0	25	0	30	ns

Notes:

1. Test conditions assume signal transition times of 5 ns or less, timing reference levels of 1.5V, input pulse levels of 0.4V to 2.2V and output loading specified in Figure 1.
2. Tested with the load in Figure 2. Transition is measured ± 500 mV from steady-state voltage. Not 100% tested.

AC TEST CONDITIONS

Parameter	Unit
Input Pulse Level	0.4V to 2.2V
Input Rise and Fall Times	5 ns
Input and Output Timing and Reference Level	1.5V
Output Load	See Figures 1 and 2

AC TEST LOADS

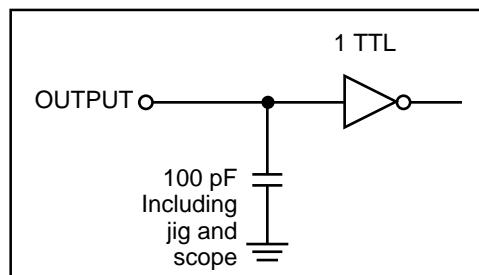


Figure 1

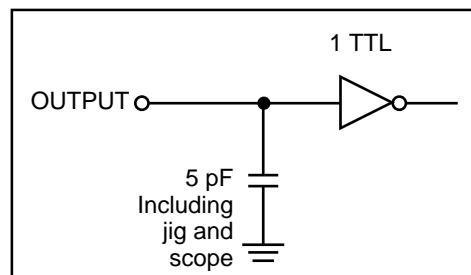
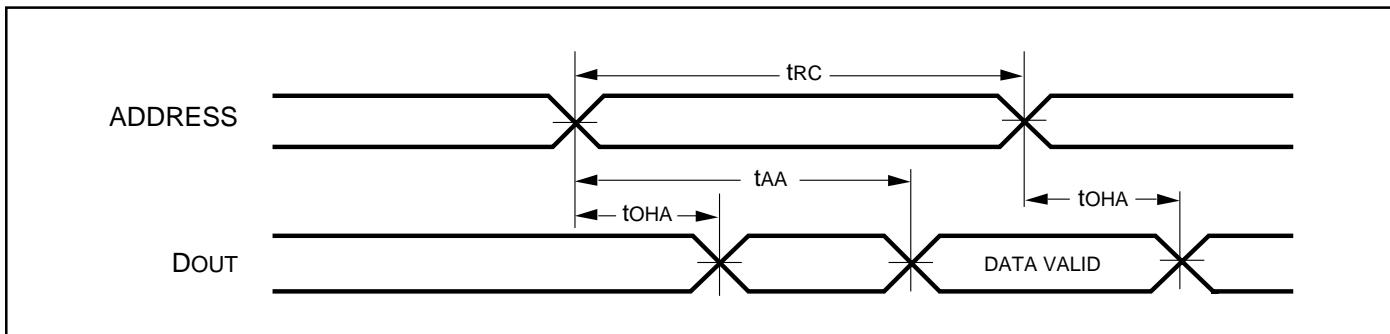
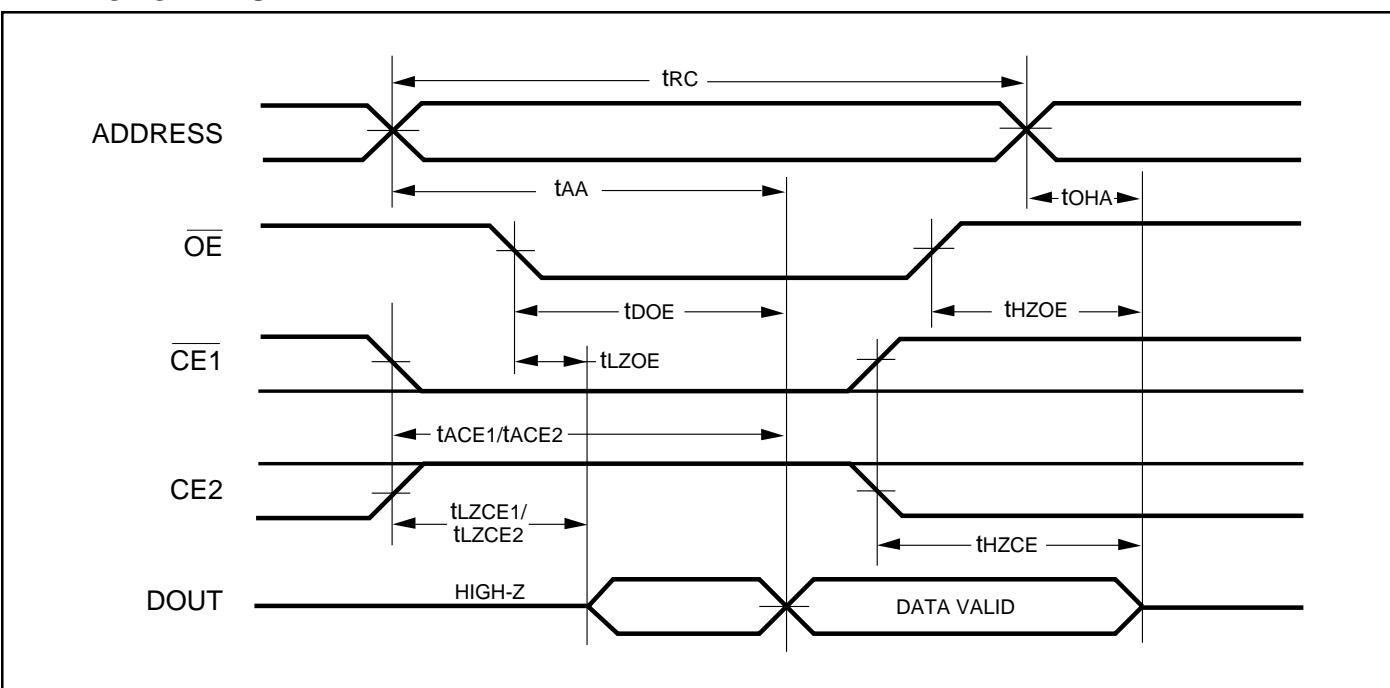


Figure 2

AC TEST LOADS
READ CYCLE NO.1^(1,2)



AC WAVEFORMS
READ CYCLE NO. 2^(1,3)



Notes:

1. WE is HIGH for a Read Cycle.
2. The device is continuously selected. \overline{OE} , $\overline{CE1} = V_{IL}$, $CE2 = V_{IL}$.
3. Address is valid prior to or coincident with $\overline{CE1}$ LOW and $CE2$ HIGH transitions.

WRITE CYCLE SWITCHING CHARACTERISTICS^(1,2) (Over Operating Range, Standard and Low Power)

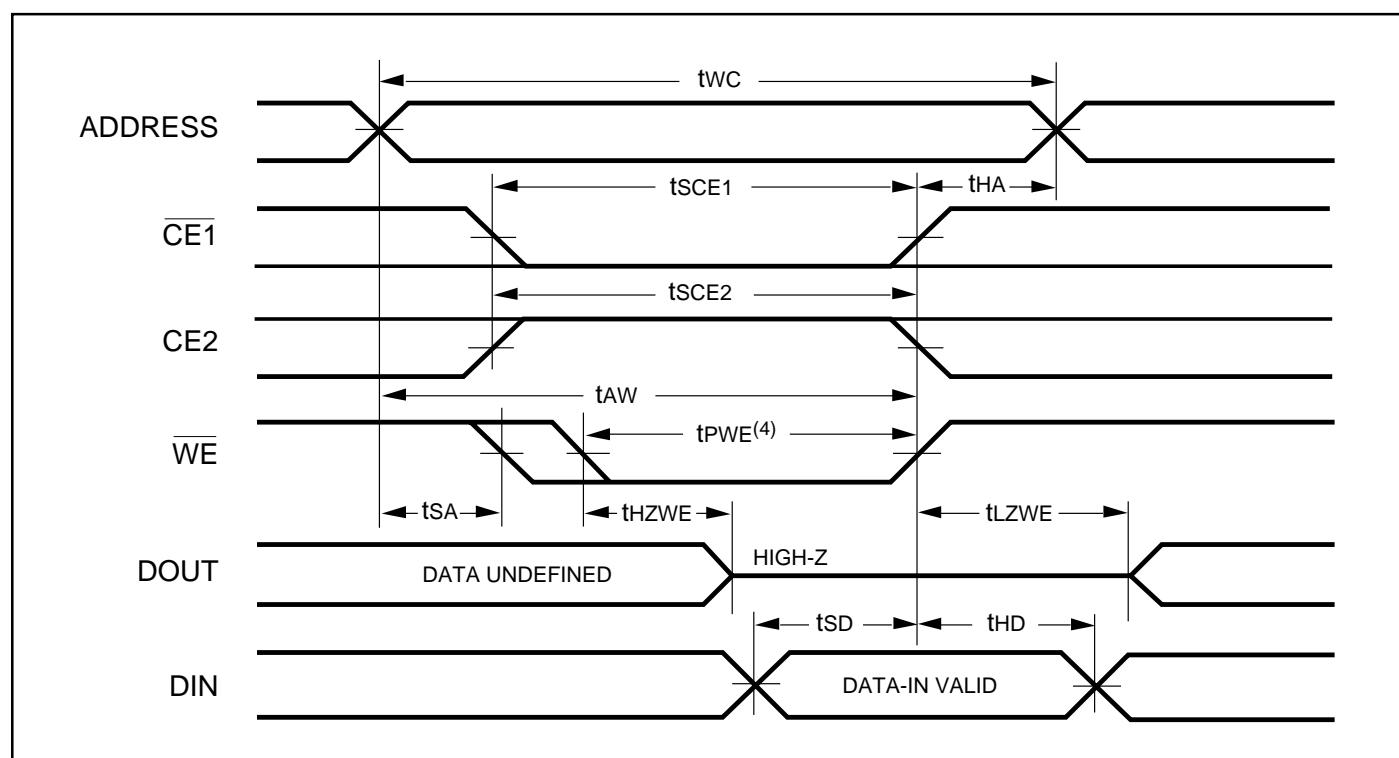
Symbol	Parameter	-55		-70		-100		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	
t _{WC}	Write Cycle Time	55	—	70	—	100	—	ns
t _{SCE1}	$\overline{CE1}$ to Write End	45	—	65	—	80	—	ns
t _{SCE2}	CE2 to Write End	45	—	65	—	80	—	ns
t _{AW}	Address Setup Time to Write End	45	—	65	—	80	—	ns
t _{HA}	Address Hold from Write End	0	—	0	—	0	—	ns
t _{SA}	Address Setup Time	0	—	0	—	0	—	ns
t _{PWE⁽⁴⁾}	\overline{WE} Pulse Width	50	—	55	—	70	—	ns
t _{SD}	Data Setup to Write End	25	—	30	—	40	—	ns
t _{HD}	Data Hold from Write End	0	—	0	—	0	—	ns
t _{HZWE⁽³⁾}	\overline{WE} LOW to High-Z Output	—	25	—	25	—	30	ns
t _{LZWE⁽³⁾}	\overline{WE} HIGH to Low-Z Output	5	—	5	—	5	—	ns

Notes:

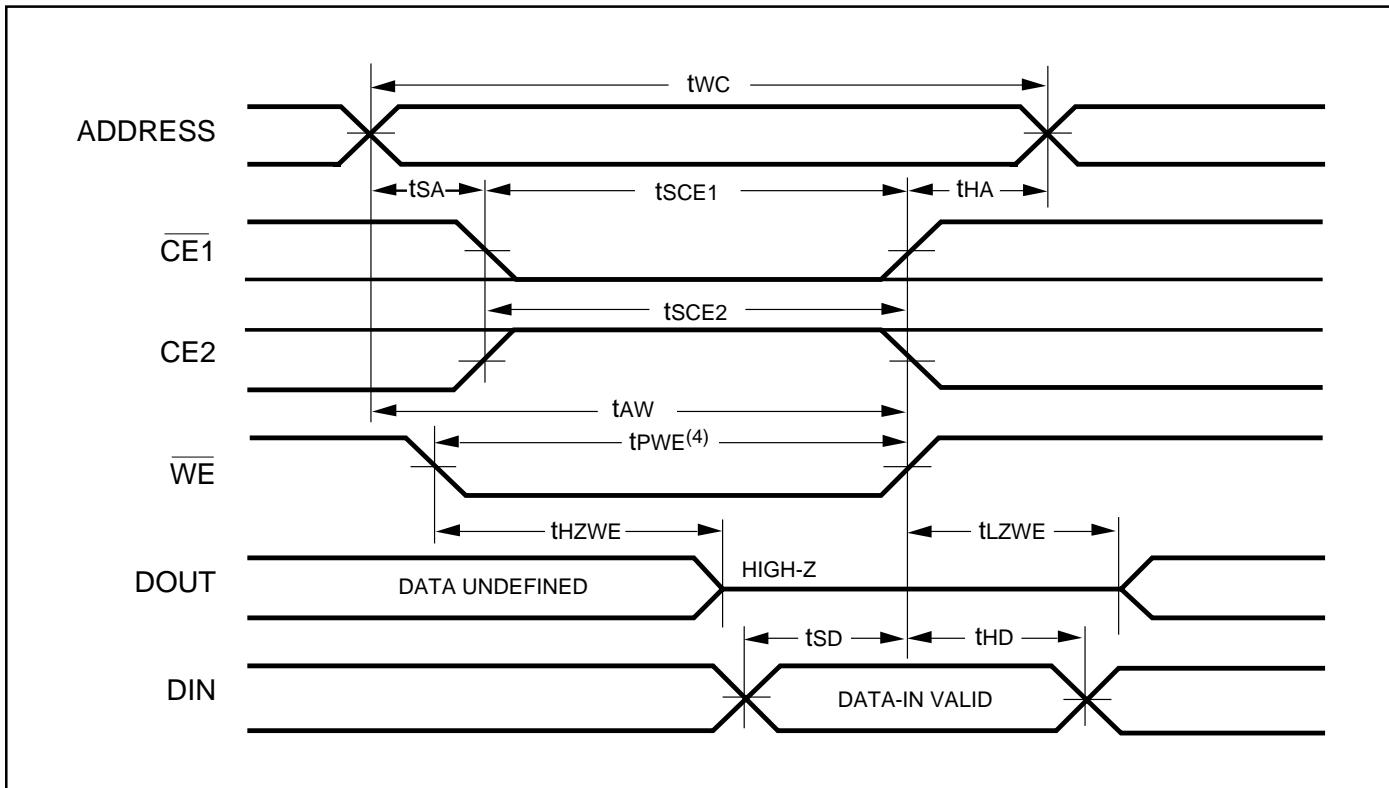
1. Test conditions assume signal transition times of 5 ns or less, timing reference levels of 1.5V, input pulse levels of 0.4V to 2.2V and output loading specified in Figure 1.
2. Tested with the load in Figure 2. Transition is measured ± 500 mV from steady-state voltage. Not 100% tested.
3. The internal write time is defined by the overlap of $\overline{CE1}$ LOW, CE2 HIGH and \overline{WE} LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the Write.
4. Tested with \overline{OE} HIGH.

AC WAVEFORMS

WRITE CYCLE NO. 1 (\overline{WE} Controlled)^(1,2)



WRITE CYCLE NO. 2 ($\overline{CE1}$, CE2 Controlled)^(1,2)



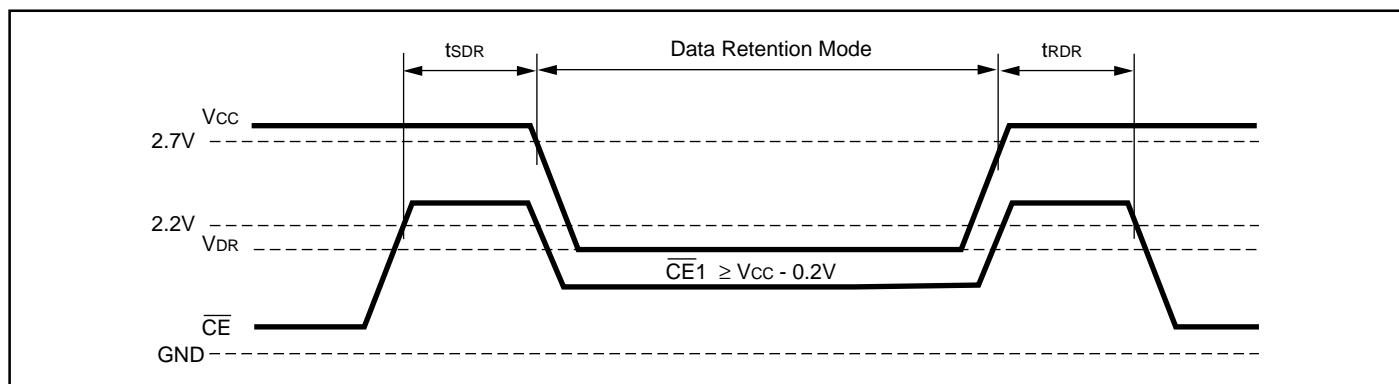
Notes:

1. The internal write time is defined by the overlap of $\overline{CE1}$ LOW, CE2 HIGH and \overline{WE} LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the Write.
2. I/O will assume the HIGH-z state if $\overline{OE} = V_{IH}$.

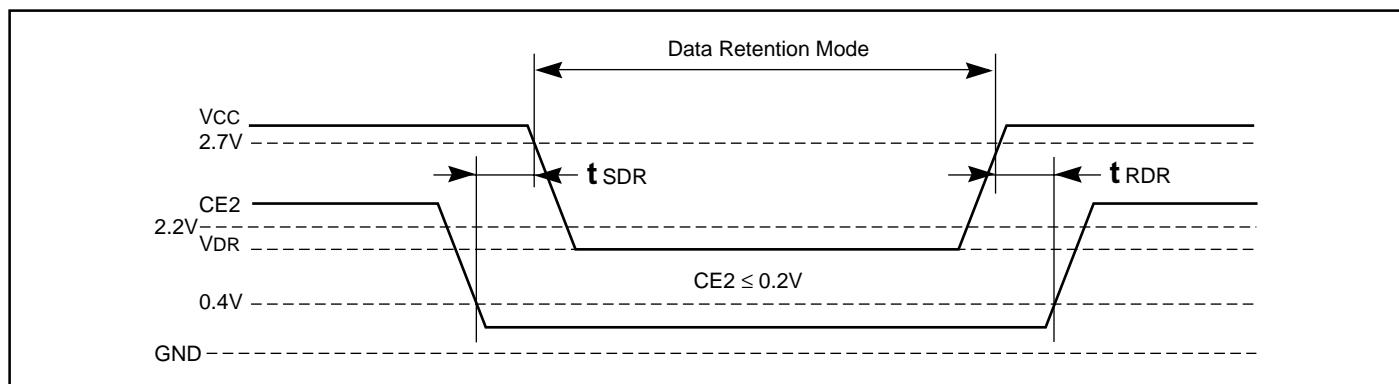
DATA RETENTION SWITCHING CHARACTERISTICS

Symbol	Parameter	Test Condition		Min.	Max.	Unit
V_{DR}	Vcc for Data Retention	See Data Retention Waveform		1.5	3.6	V
I_{DR}	Data Retention Current	$V_{cc} = 2.0V, \overline{CE1} \geq V_{cc} - 0.2V$	Com. (-L) Com. (-LL) Ind. (-L) Ind. (-LL)	— — — —	20 5 25 7	μA
t_{SDR}	Data Retention Setup Time	See Data Retention Waveform		0	—	ns
t_{RDR}	Recovery Time	See Data Retention Waveform		t_{RC}	—	ns

DATA RETENTION WAVEFORM ($\overline{CE1}$ Controlled)



DATA RETENTION WAVEFORM (CE2 Controlled)



ORDERING INFORMATION

Commercial Range: 0°C to +70°C

Speed (ns)	Order Part No.	Package
55	IS62LV2568L-55T	8*20mm TSOP-1
	IS62LV2568L-55H	8*13.4mm TSOP-1
	IS62LV2568L-55B	6*8mm TF-BGA
70	IS62LV2568L-70T	8*20mm TSOP-1
	IS62LV2568L-70H	8*13.4mm TSOP-1
	IS62LV2568L-70B	6*8mm TF-BGA
100	IS62LV2568L-100T	8*20mm TSOP-1
	IS62LV2568L-100H	8*13.4mm TSOP-1
	IS62LV2568L-100B	6*8mm TF-BGA

Industrial Range: -40°C to +85°C

Speed (ns)	Order Part No.	Package
55	IS62LV2568L-55TI	8*20mm TSOP-1
	IS62LV2568L-55HI	8*13.4mm TSOP-1
	IS62LV2568L-55BI	6*8mm TF-BGA
70	IS62LV2568L-70TI	8*20mm TSOP-1
	IS62LV2568L-70HI	8*13.4mm TSOP-1
	IS62LV2568L-70BI	6*8mm TF-BGA
100	IS62LV2568L-100TI	8*20mm TSOP-1
	IS62LV2568L-100HI	8*13.4mm TSOP-1
	IS62LV2568L-100BI	6*8mm TF-BGA



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